Introduction

This document describes a PCB antenna designed for operation in the 868 MHz, 915 MHz and 955 MHz ISM bands. This antenna can be used with all transceivers and transmitters from Texas Instruments, which operates in these frequency bands. Maximum gain is measured to be $-0.12 \text{ dB}$ and overall size requirements for this antenna are 43 x 20 mm. Thus this is a medium size, low cost antenna solution. Figure 1 shows a picture of the board being used to develop and characterize this antenna. The board is pin compatible with CC1110 EM and is equipped with two LEDs, a push button, a 10-pin debug connector and a 2-pin power connector for test and characterization purpose.
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2 Abbreviations

CAD   Computer Aided Design
CF    Correction Factor
dB    decibel
EB    Evaluation Board
EM    Evaluation Module
ETSI  European Telecommunications Standards Institute
FCC   Federal Communications Commission
FR-4  Flame Retardant 4
GHz   Giga Hertz
IFA   Inverted F Antenna
I/O   Input/Output
ISM   Industrial, Scientific, Medical
kBaud kilo Baud
LED   Light Emitting Diode
MHz   Mega Hertz
mm    millimeter
PA    Power Amplifier
PCB   Printed Circuit Board
PER   Packet Error Rate
RF    Radio Frequency
3 Description of the PCB Antenna

The antenna described in this document is an inverted F antenna. Since the impedance of this antenna is approximately matched to 50 ohm, no external matching components are needed. The size of the ground plane affects the impedance of the antenna. This PCB antenna reference design has included the option for one series and two shunt components at the feed point of the antenna. These can be used to compensate for detuning caused by plastic encapsulation and other object in the vicinity of the antenna. For further information on impedance matching and impedance measurements, see AN058 Antenna Selection Guide [1].

For test purpose the antenna has been implemented on an evaluation module equipped with two LEDs and a push button for running small test programs. The evaluation module can be connected to SmartRF04EB via a 10-pin debug cable for programming. The module is also equipped with a two pin power connector (3 volt) and soldering points for the chip's I/O-ports. The external power must be disconnected when the module is connected to SmartRF04EB.

3.1 Implementation of the Inverted F Antenna

To obtain optimum performance it is important to make an exact copy of the antenna dimensions. The antenna was implemented on a 0.8 mm thick FR-4 substrate. Since there is no ground plane beneath the antenna the PCB thickness is not critical, but if a different thickness is being used it might be necessary to tune the length of the antenna to obtain optimum performance.

One approach to implement the antenna in a PCB CAD tool is to import the antenna layout from a Gerber file. Such a file is included in the CC1110EM IIFA Reference Design [2], and is called “antenna.spl”. If the antenna is implemented on a PCB that is wider than the antenna, it is important to avoid placing components or having a ground plane close (minimum 5 mm) to each side of the antenna. If the CAD tool being used does not support import of Gerber files, Figure 2 and Table 1 can be used.
Figure 2. Antenna Dimensions

<table>
<thead>
<tr>
<th>L1</th>
<th>20.0 mm</th>
<th>L7</th>
<th>43.0 mm</th>
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<tr>
<td>L2</td>
<td>5.0 mm</td>
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<td>L3</td>
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<td>10.0 mm</td>
<td>W</td>
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<tr>
<td>L5</td>
<td>6.0 mm</td>
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<tr>
<td>L6</td>
<td>17.0 mm</td>
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</table>

Table 1. Antenna Dimensions

Optimum length for L6 is dependent on the geometry and size of the ground plane. With the ground plane shown Figure 2 (31 x 45 mm) L6 should be approx. 9 mm for 868 MHz and 1 mm for 915 MHz. The antenna can also be used for 955 MHz, but then the total length of the antenna has to be reduced more than the length specified for 915 MHz. Bigger ground planes might require additional tuning.
4 Results

Measurement results are presented in this section. Notice that the performance will be affected by the size and shape of the ground plane.

4.1 Radiation Pattern

Figure 3 shows how to relate the radiation patterns in this section to the orientation of the antenna. The pictures in Figure 3 shows how the board was placed when measuring the different planes. For all measurements the board was turned around a vertical axis and 0° corresponds to the direction out of the picture and. The radiation patterns were measured with 10 dBm output power.

Notice that the size of the ground plane will affect the radiation pattern, hence implementing this antenna on a board with a different size and shape of the ground plane will most likely affect the radiation pattern. These measurements were performed with the small ground plane shown in Figure 2.

The values in the plots of the antenna patterns are in dBm and represents gain relative to 10 dBm and 5 dBm in the plot equals a gain of −5 dB, etc.

![XY plane](image)

![XZ plane](image)

![YZ plane](image)

Figure 3. How to Relate the Antenna to the Radiation Patterns
Figure 4. XY Plane Horizontal Polarization

Figure 5. XY Plane Vertical Polarization
Figure 6. YZ Plane Horizontal Polarization

Figure 7. YZ Plane Vertical Polarization
Figure 8. XZ Plane Horizontal Polarization

Figure 9. XZ Plane Vertical Polarization
4.2 Reflection

Figure 10. Measured Reflection at the End of a 15 mm long, 50 Ω, Line Feeding the Antenna. (The values in the box represent different lengths of L6.)

Figure 11. Measured Reflection at the Feed Point of the Antenna. (The values represent subtracted length of the antenna in addition to removing L6 completely.)
Figure 10 shows that the antenna reflects less than 10% of the available power for a bandwidth of approximately 50 MHz. It is also clear from Figure 10 that the antenna is easily tuned to the desired center frequency simply by adjusting the length of the antenna.

As shown in Figure 11, this antenna could also be used in the frequency band around 950 MHz. The bandwidth for this frequency is not great, ~25 MHz, thus requiring precise tuning.

Measurements performed on the antenna with bigger ground planes show that further trimming of the antenna length might be required. However, the ground plane size will not result in any big changes in reflection or bandwidth.

Measurements also show that it is possible to place ground planes on the side of the antenna. Minimum recommended distance from the antenna to the ground plane is in this case 15 mm. Ground plane on the side(s) of the antenna will not have much effect on the impedance, but will result in changes in the distribution of the radiated power.

4.3 Bandwidth

To measure the bandwidth of the antenna a small test program, stepping a 10 dBm carrier from 782 MHz to 950 MHz, was used. By using the “Max Hold” option on the spectrum analyzer it is possible to see how the output power varies across frequency when using this test program.

Notice that the bandwidth characteristic is dependent on direction and polarization. The result shown in Figure 12 and Figure 13 is based on a measurement performed with the PCB horizontally oriented (XY-plane, $\varphi = 0^\circ$) and the antenna pointing towards a vertical polarized receiving antenna. The measurement is uncompensated so 38.19 dB has to be added to the received power.

The antenna can also be used for 955 MHz but then the total length of the antenna has to be reduced more than the length specified for 915 MHz.

![Figure 12. Bandwidth of Antenna Tuned for 868 MHz (L6 = 11 mm)](image)
Notice that the measurements were performed with two different settings for the PA-register. In Figure 12 the PA was optimized for 868 MHz (PA_TABLE = 0xC2) and in Figure 13 the PA was optimized for 915 MHz (PA_TABLE = 0xC0).

### 4.4 Harmonic Emission

Measurement of harmonic emission has not been done for this antenna. Harmonic emission will be dependent on ground plane geometry, encapsulation etc. Thus this measurement should be performed on a complete prototype. Table 2 shows the FCC- and ETSI limits. Above 1 GHz, FCC allows the radiation to be up to 20 dB above the limits given in Table 2, if duty cycling is being used. The second harmonic would only be an issue when qualifying under FCC part 15.249 since 15.247 only requires 20 dBc. Notice that programmed output power and size of the ground plane will affect the level of the harmonics and thus determine the necessary duty cycling.

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<td>54 dBV/m</td>
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<td>54 dBV/m</td>
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<td>Limit ETSI</td>
<td>-30 dBm</td>
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</table>

Table 2. ETSI and FCC Limits for Harmonic Radiation
The allowed additional emission, or correction factor, is calculated based on maximum transmission time during 100 ms. Equation 1 can be used to calculate the correction factor, where \( t \) is equal to maximum transmission time during 100 ms. Using Equation 1 it can be calculated that a maximum transmission time of 50 ms, during 100 ms, will permit all radiation above 1 GHz to be 6 dB above the given limits.

\[
CF = -20 \cdot \log\left(\frac{t}{100\text{ms}}\right)
\]

Equation 1. FCC Correction Factor

4.5 Range

Measurements of the antenna range have been performed outdoors, in line of sight with two equal antennas as sender and receiver. The measurements were done with both antennas aligned with the YZ-plane horizontally (\( \phi = 0^\circ \)). At a data rate of 38.4 kBaud a range of over 1300 meters was achieved (PER = 1 %). The measurements were performed with the prototype boards connected to a SmartRF04EB by cable, so the effective ground plane was only 31 x 45 mm.

5 Conclusion

The antenna proposed in this design note can be used for 868 MHz, 915 MHz and 955 MHz operation. Required board size for this antenna is 43 x 20 mm and maximum gain is approximately 0 dB dependent on direction. Measurements of reflection show that the center frequency is easily adjusted by trimming the antenna length. The radiation patterns show wide distribution of the radiated power.

<table>
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<th>Antenna Size</th>
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<tr>
<td>Range</td>
<td>(~1300\text{ m (line-of-sight)})</td>
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<tr>
<td>Max Gain in XY Plane</td>
<td>(~6.54\text{ dB})</td>
</tr>
<tr>
<td>Max Gain in XZ Plane</td>
<td>(~5.95\text{ dB})</td>
</tr>
<tr>
<td>Max Gain in YZ Plane</td>
<td>(~0.12\text{ dB})</td>
</tr>
<tr>
<td>Reflection</td>
<td>(&lt; -25\text{ dB})</td>
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</tbody>
</table>

Table 3. Key Parameters
6 References


7 General Information

7.1 Document History

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<tr>
<th>Revision</th>
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<td>Updated values in Table 1.</td>
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<td>SWRA228B</td>
<td>2009.07.28</td>
<td>Added abbreviations. Cosmetic changes</td>
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